

SGA-1263(Z) DCto4000MHz SILICON GERMANIUM HBT **CASCADABLE GAIN BLOCK**

Package: SOT-363



Si BJT

GaN HEMT

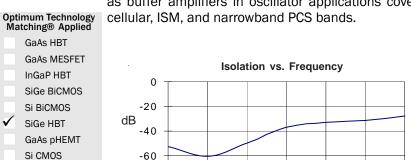
InP HBT **RF MEMS**

LDMOS

Product Description

RFMD's SGA-1263(Z) is a Silicon Germanium HBT Heterostructure Bipolar Transistor (SiGe HBT) amplifier that offers excellent isolation and flat gain response for application to 4GHz. This RFIC is a 2-stage design that provides high isolation of up to 40dB at 2GHz and is fabricated using the latest SiGe HBT 50GHz FT process, featuring one-micron emitters with V_{CEO} >7 V. These unconditionally stable amplifiers have less than 1dB gain drift over 125°C operating range (-40°C to +85°C) and are ideal for use

as buffer amplifiers in oscillator applications covering



200

006

-80

8

Features

- DCto400MHz Operation
- Single Supply Voltage
- Excellent Isolation, >50dB at 900 MHz
- 50W In/Out, Broadband Match for Operation from DC-4GHz
- Unconditionally Stable

Applications

- Buffer Amplifier for Oscillator Applications
- Broadband Gain Blocks
- IF Amp

Parameter	Specification			Unit	Condition
	Min.	Тур.	Max.	Unit	Condition
Small Signal Gain	15	17	19	dB	850MHz
	12	15	17	dB	1950MHz
Output Power at 1dB Compression	-13.0	-9.5		dBm	1950MHz
Output Third Order Intercept Point	-1.5	1.0		dBm	1950MHz
Determined by Return Loss (<-10dB)				MHz	
Input Return Loss	9.5	11.2		dB	1950MHz
Output Return Loss	7	8		dB	1950MHz
Noise Figure		2.5	4.0	dB	1950MHz
Device Voltage	2.5	2.8	3.1	V	
Thermal Resistance		255		°C/W	

2400

006

Frequency MHz

3500

6000

Test Conditions: $V_S = 5V$, $I_D = 8$ mA Typ., OIP3 Tone Spacing = 1MHz, P_{OUT} per tone = -20 dBm, $R_{BIAS} = 270\Omega$, $T_L = 25$ °C, $Z_S = Z_L = 50\Omega$

SGA-1263(Z)



Absolute Maximum Ratings

-		
Parameter	Rating	Unit
Max Device Current (ID)	20	mA
Max Device Voltage (VD)	5	V
Max RF Input Power	-12	dBm
Max Junction Temperature (TJ)	+150	°C
Operating Temperature Range (TL)	-40 to +85	°C
Max Storage Temperature	+150	°C

Operation of this device beyond any one of these limits may cause permanent dam-age. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression:

 $I_D V_D < (T_J - T_L) / R_{TH}$, j-l

Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical perfor-mance or functional operation of the device under Absolute Maximum Rating condi-tions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

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Parameter	Specification			Unit	Condition	
	Min.	Тур.	Max.	Unit	Condition	
Bandwidth					T=25°C	
Frequency Range	DC		4000	MHz		
Device Bias					T=25°C	
Operating Voltage		2.8		V		
Operating Current		8		mA		
500MHz					T=25°C	
Gain		16.0		dB		
Noise Figure		2.7		dB		
Output IP3		4.0		dBm		
Output P1dB		-6.9		dBm		
Input Return Loss		8.5		dB		
Isolation		61.6		dB		
850MHz					T=25°C	
Gain		15.7		dB		
Noise Figure		2.7		dB		
Output IP3		2.6		dBm		
Output P1dB		-7.8		dBm		
Input Return Loss		8.9		dB		
Isolation		48.4		dB		
1950 MHz					T=25°C	
Gain		14.7		dB		
Noise Figure		3.0		dB		
Output IP3		2.8		dBm		
Output P1dB		-7.4		dBm		
Input Return Loss		8.8		dB		
Isolation		35.6		dB		
2400 MHz					T=25°C	
Gain		14.2		dB		
Noise Figure		2.8		dB		
Output IP3		0.2		dBm		
Output P1dB		-7.0		dBm		
Input Return Loss		8.4		dB		
Isolation		33.6		dB		

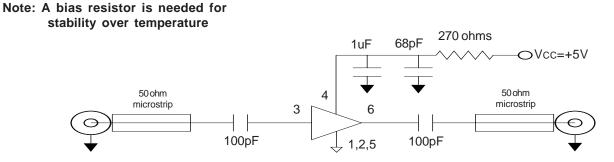




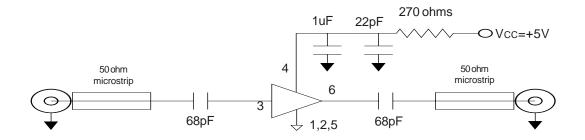
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Pin	Function	Description
1	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.
2	GND	Same as Pin 1.
3	RF IN	RF input pin. This pin requires the ise of an external DC blocking capacitor chosen for the frequency of operation.
4	VCC	Supply Connection. This pin should be bypassed with suitable capacitor(s).
5	GND	Same as Pin 1.
6	RF OUT	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper oper ation.

Application Schematic for +5V Operation at 900 MHz



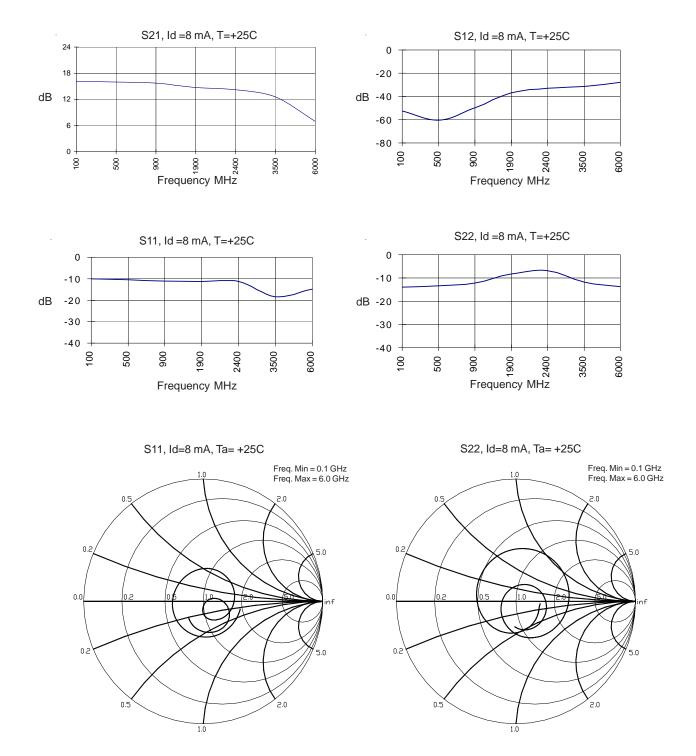
Application Schematic for +5V Operation at 1900 MHz



Recommended Bias Resistor				or Valu	es
Supply Voltage(Vs)	3.6V	5V	7.5V	9V	12V
Rbias (Ohms)	100	275	588	775	1150

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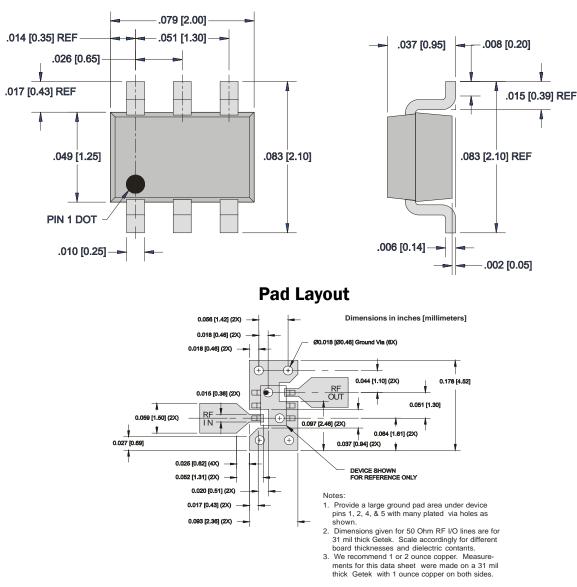




DS090924







Package Dimensions



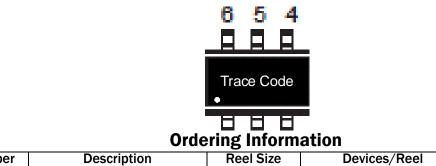


Part Identification Marking



RoHS Compliant part will be indicated with a "12Z" part marking.

Alternate Marking with Trace Code Only



Part Number	Description	Reel Size	Devices/Reel
SGA-1263	Tin-Lead	7"	3000
SGA-1263Z	Lead Free, RoHS Compliant	7"	3000